

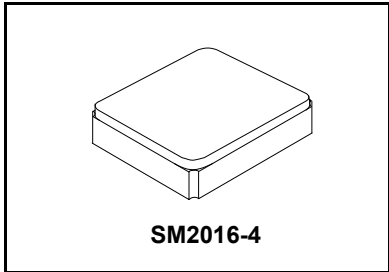


- **Designed for Front End GPS, and Glonass Applications**
- **Steep Rejection**
- **2.0 x 1.6 x 1.0 mm Surface-Mount Case**
- **No Matching Circuit Required**
- **Complies with Directive 2002/95/EC (RoHS)**
- **AEC-Q200 Qualified**

RoHS  
Compliant

**SF2316H-1**

**1588.655 MHz  
SAW Filter**



**Absolute Maximum Ratings**

Rating	Value	Units
Maximum Input Power	+20	dBm
DC Voltage	3	VDC
Operating Temperature	-40 to +105	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Storage Temperature Range without Tape and Reel	-40 to +105	°C
Maximum Soldering Profile (5 cycles maximum)	260 °C for 10 s	

**Electrical Characteristics**

Characteristic 25°C	Sym	Notes	Min.	Typ	Max.	Units
Center Frequency	fC			1588.656		MHz
Insertion Loss, 1573.42 to 1577.42 MHz	IL			1.25	2.2	dB
Insertion Loss, 1571.42 to 1605.89 MHz				1.65	2.7	
Amplitude Ripple, 1573.42 to 1577.42 MHz				0.25	1.2	
Amplitude Ripple, 1571.42 to 1605.89 MHz				0.46	1.5	
I/O VSWR 1571.42 to 1605.89 MHz				1.85	2	
Attenuation Referenced to 0dB:						
0 to 915 MHz			30	36		dB
915 to 1452 MHz			28	36		
1452 to 1525 MHz			32	42		
1548.5 MHz			10	18		
1710 to 1850 MHz			28	40		
1850 to 6000 MHz			20	24		
Standard Reel Quantity	Reel Size - 7 inch		2000 pieces/reel			
	Reel Size - 13 inch		10000 pieces/reel			

Single-ended Input / Output Impedance Match	No matching network required for operation at 50 ohms
Package Size	SM2016-4
Lid Symbolization (Y=year, W=week)	5K, <u>YW</u>



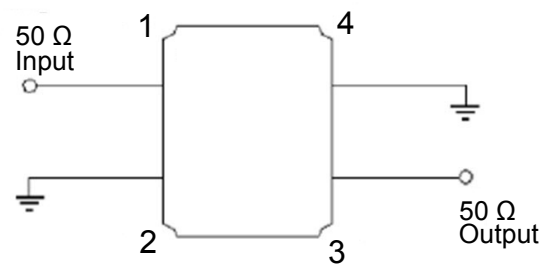
**CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

**NOTES:**

1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.

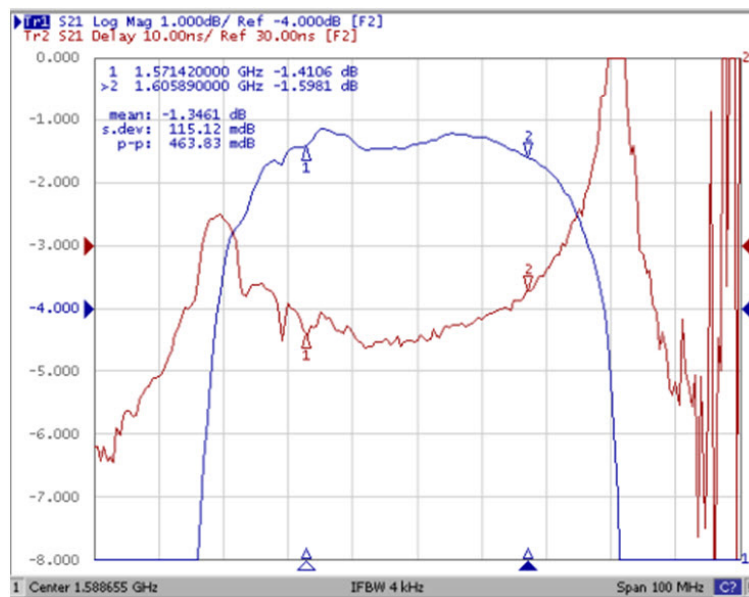
## Electrical Connections

Connection	Terminals
Input	1
Output	3
Ground	All others

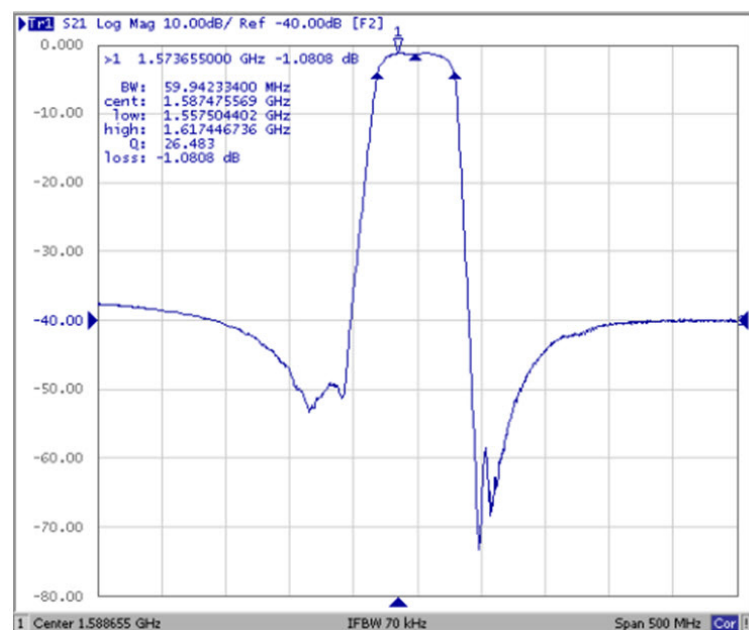


## Frequency Characteristics

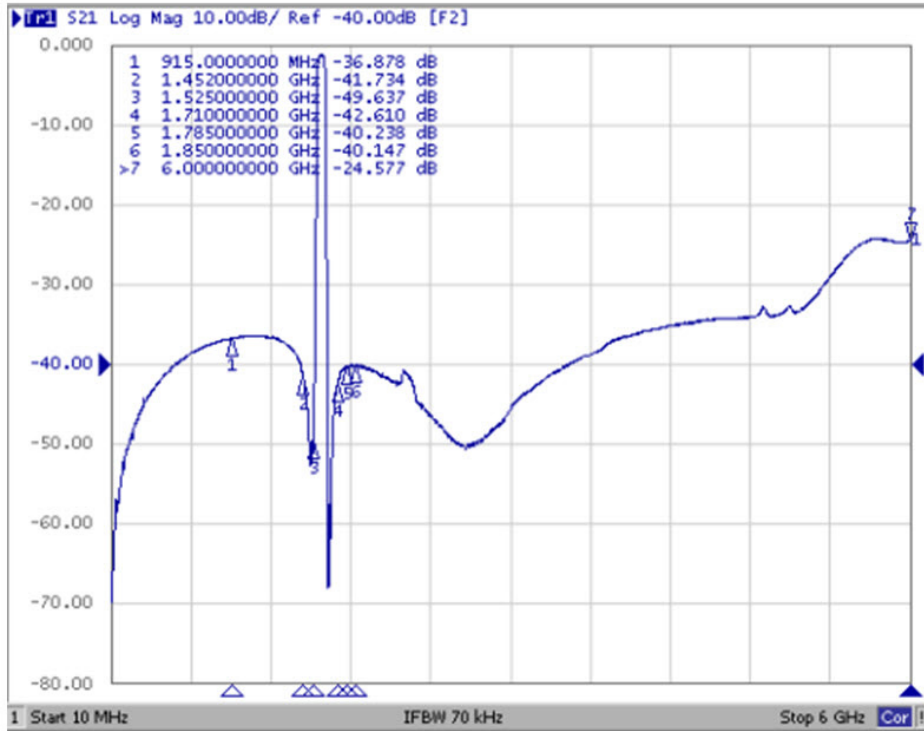
### S21 Response: span 100 MHz



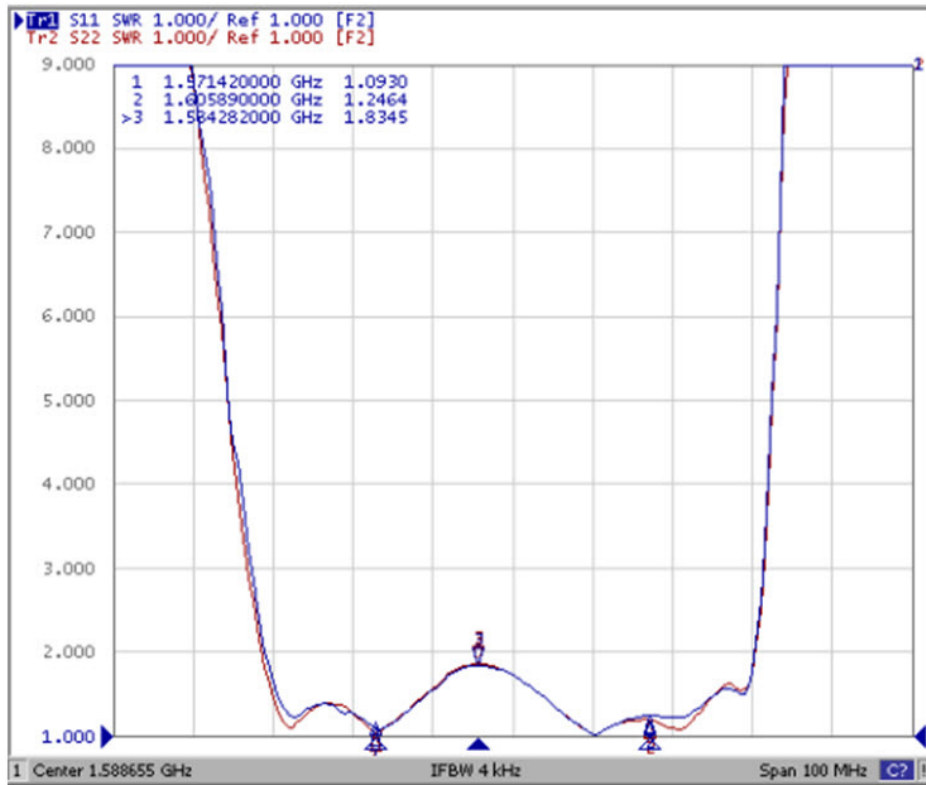
### S21 Response: span 300 MHz



**S21 Response: span 6 GHz**



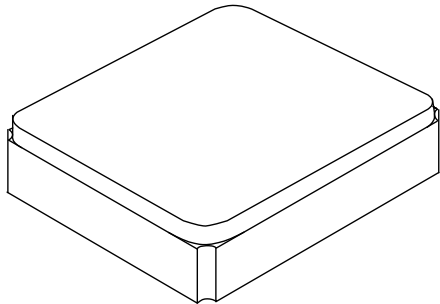
**S11 & S22 VSWR - span 100 MHz**



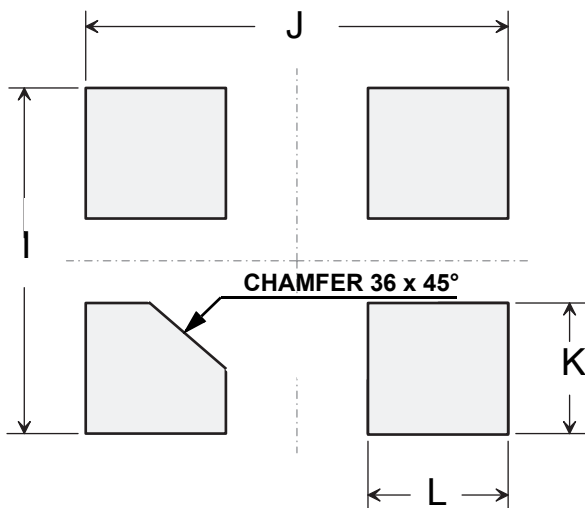
# SM2016-4 Case

## 4-Terminal Ceramic Surface-Mount Case

### 2.0 X 1.6 mm Nominal Footprint



PCB PAD LAYOUT



Dimensions in mm

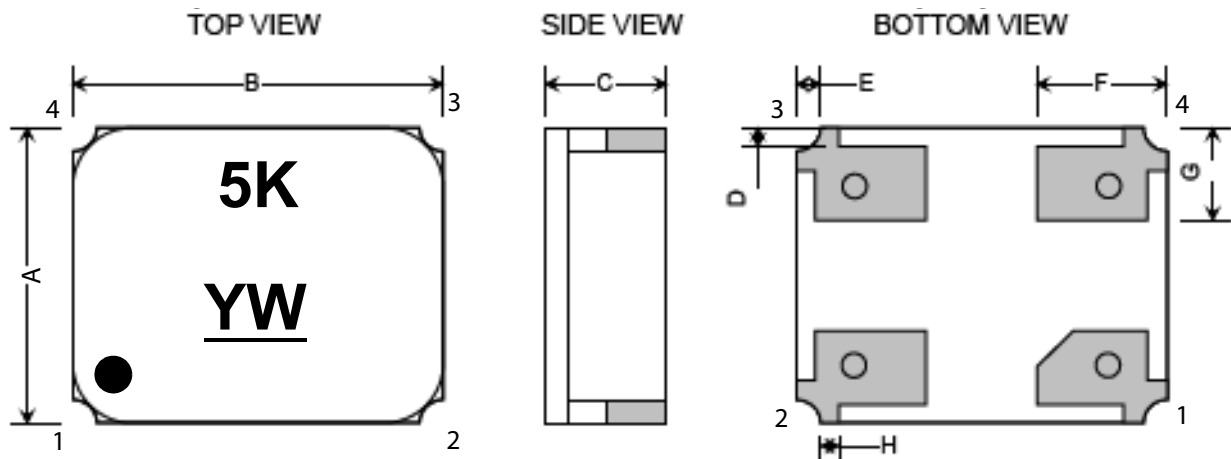
All pads have the same dimensions

Case Dimensions

Dimension	mm		
	Min	Nom	Max
A	1.57	1.60	1.73
B	1.97	2.00	2.13
C	0.55	0.65	0.75
D		0.10	
E		0.10	
F		0.70	
G		0.50	
H		0.10	
I		1.80	
J		2.20	
K		0.60	
L		0.80	

Materials

Solder Pad Plating	0.3 to 1.0 $\mu\text{m}$ Gold over 1.27 to 8.89 $\mu\text{m}$ Nickel
Lid Plating	2.0 to 3.0 $\mu\text{m}$ Nickel
Body	$\text{Al}_2\text{O}_3$ Ceramic
Pb Free	



## Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
4. Time: 5 times maximum.

